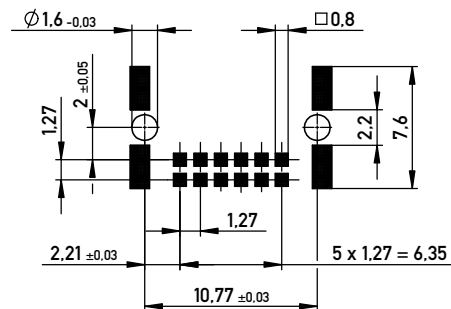
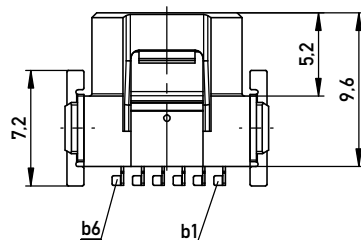
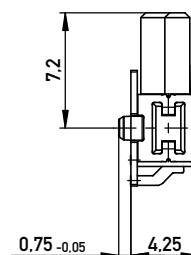
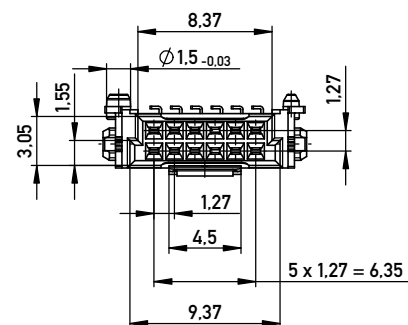
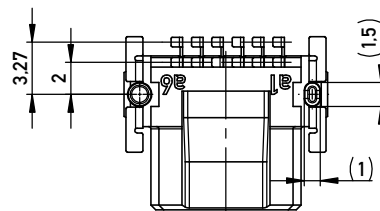
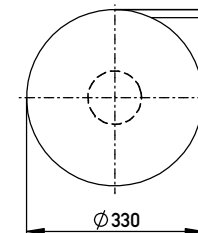


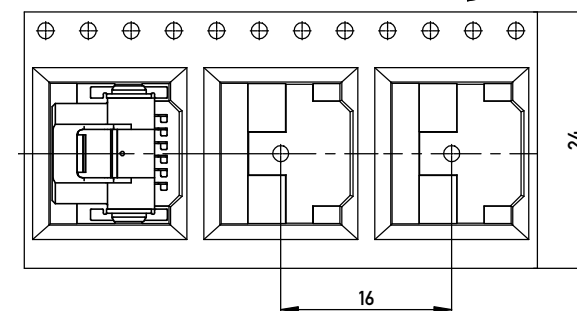
Leiterplatten-Layout Vorschlag für SMT PCB-Layout Proposal for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
Packaging unit: 560 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

mit Verriegelung, ohne Hilfsmittel lösbar, Bauteilfarbe: schwarz

with locking mechanism, without tool unlockable, component color: black

Information:	Tolerances		Scale	3:1
	All Dimensions in mm			
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			Federl. SMC-Q 12-SMD-BA7 Female SMC-Q 12-SMD-type7	
b	23.04.2014	 www.ERNI.com		100200410001
Index	Date			K A3
			Class	SMCQ

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